PARA LIGHT ELECTRONICS CO., LTD.
4F, No.1, Lane 93, Chien Yi Road, Chung Ho City, Taipei, Taiwan
Tel: 886-2-2225-3733 Fax: 886-2-2225-4800
E-mail: para@para.com.tw http://www.para.com.tw

DATA SHEET

PART NO.: L-T677WDTZ-U1

REV: A / 3

CUSTOMER'S APPROVAL : _____ DCC : _____

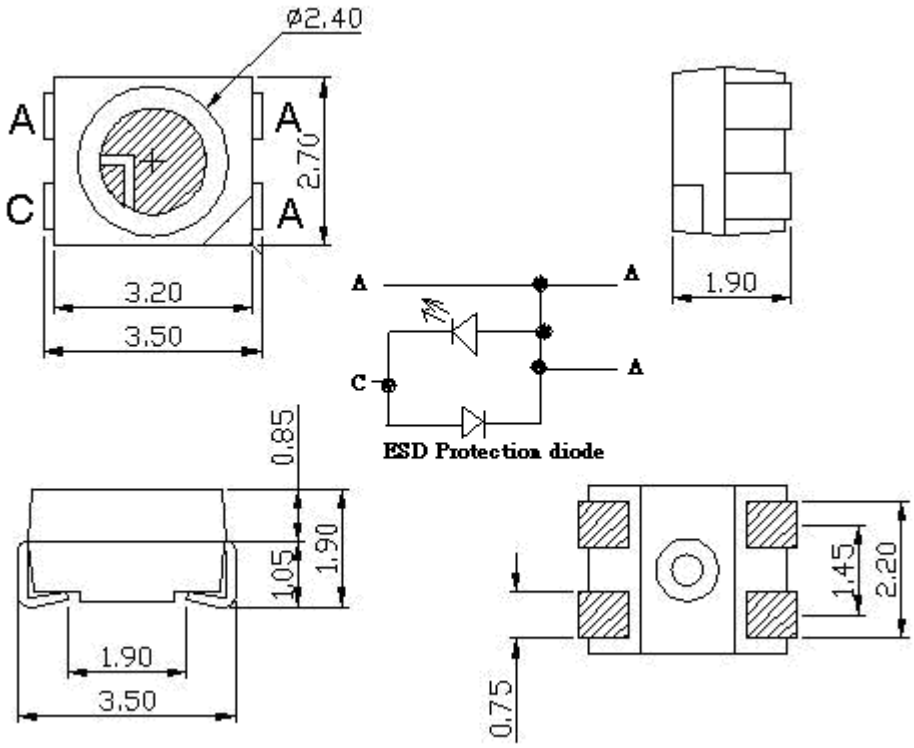
Features

- Top view, Wide view angle, Warm White color PLCC4 package SMD LED .
- EIA STD package, packing in 8mm tape on 7" diameter reels (ANSI/EIA-481-B-2001).
- Compatible with automatic Pick & Place equipment.
- Compatible with IR Reflow soldering and TTW soldering.
- Pb free product and acceptable lead-free process!
- Meet RoHS Green Product.
- PARA LIGHT LED match with the spec of PWI part spec# 5800027-089 white LED.

Application

- Reading Lamps, Substitution of Micro Incandescent Lamps, Marker Lights.
- Emergency lighting / Signal and symbol luminaries.

Package Outline Dimensions



Notes:

1. All dimensions are in millimeters.
2. Tolerance is ± 0.10mm (.004") unless otherwise noted.

Chip Materials

- Dice Material : InGaN
- Light Color : White
- Lens Color : Light Yellow Diffused.

Absolute Maximum Ratings(Ta=25℃)

Symbol	Parameter	Rating	Unit
P_D	Power Dissipation	75	mW
I_{PF}	Peak Forward Current (1/10 Duty Cycle, 0.1ms Pulse Width)	100	mA
I_F	Continuous Forward Current	20	mA
V_R	Reverse Voltage	5	V
ESD	Electrostatic Discharge Threshold (HBM)Note A	2000	V
Topr	Operating Temperature Range	-40 ~ + 85	℃
Tstg	Storage Temperature Range	-40 ~ + 100	℃

Note A :

HBM : Human Body Model. Seller gives no other assurances regarding the ability of to withstand ESD.

Electro-Optical Characteristics (Ta=25℃)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test Condition
Luminous Intensity	IV	1400	1700		mcd	IF=20mA
Viewing Angle	2 θ 1/2		120		Deg	Note 2
CIE Chromaticity	x		0.3700			IF=20mA
CIE Chromaticity	y		0.3700			
Forward Voltage	VF	2.9	3.20	3.50	V	IF = 20mA
Color Temperature	Kelvin	3800		4600	K	IF = 20mA

Notes:

1. Luminous intensity is measured with a light sensor and filter combination that proximities the CIE eye-response curve.
2. θ 1/2 is the off-axis angle at which the luminous intensity is half the axial luminous intensity.
3. Caution in ESD :
   Static Electricity and surge damages the LED. It is recommended use a wrist band or anti-electrostatic glove when handling the LED. All devices, equipment and machinery must be properly grounded.
4. Major standard testing equipment by "Instrument System" Model : CAS140B Compact Array Spectrometer and "KEITHLEY" Source Meter Model : 2400.

Typical Electro-Optical Characteristics Curves

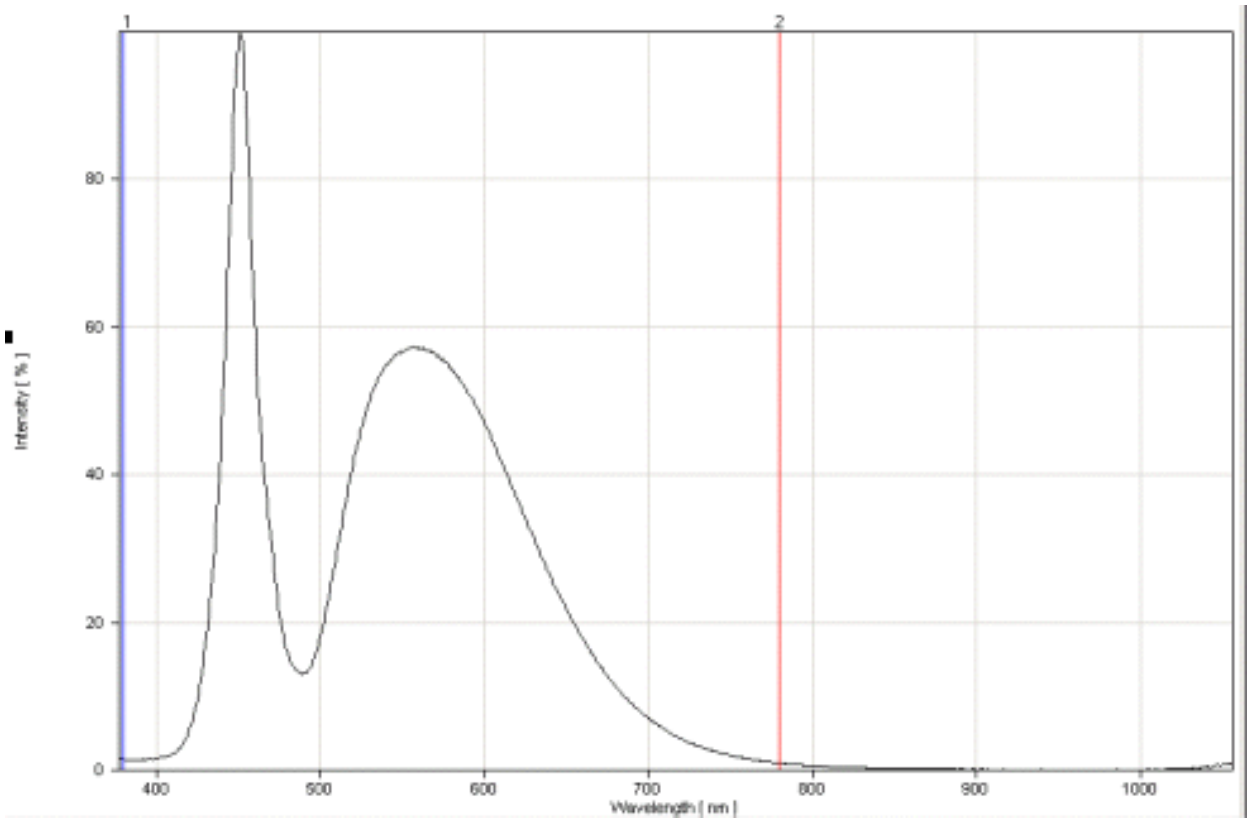


Fig.1 Relative Intensity vs. Wavelength

Typical Electro-Optical Characteristics Curves

(25℃ Ambient Temperature Unless Otherwise Noted)

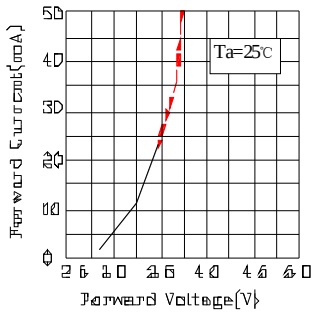


Fig.1 Forward Current vs.Forward Voltage

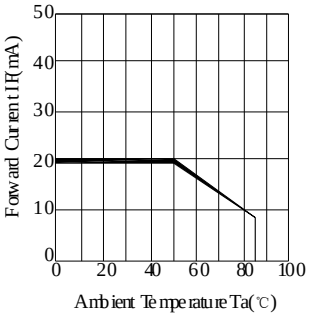


Fig.2 Forward Current Derating Curve

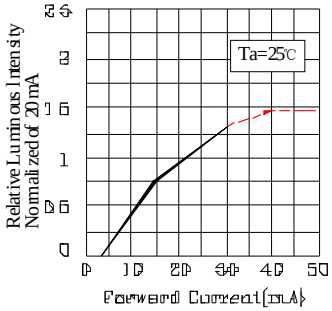


Fig.3 Relative Luminous Intensity vs.Forward Current

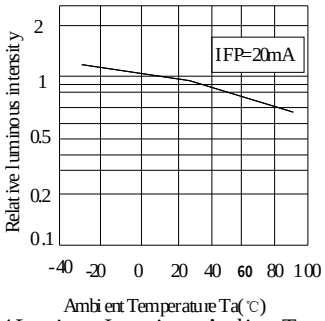


Fig.4 Luminous Intensity vs.Ambient Temperature

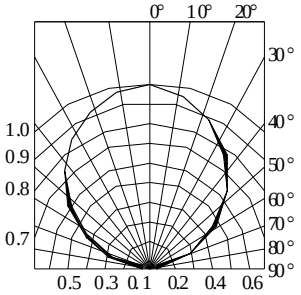


Fig.5 Spatial Distribution

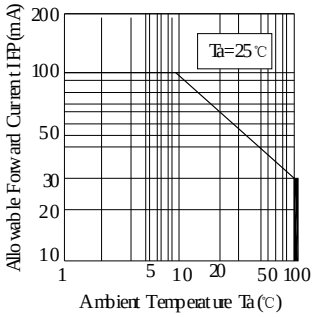


Fig.6 Forward Current Derating Curve

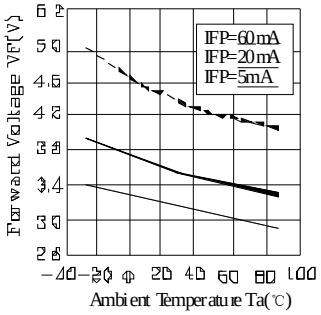


Fig.7 Ambient Temperature vs.Forward Voltage

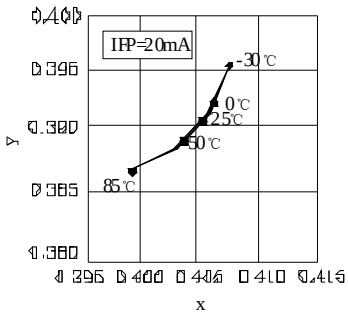


Fig.8 Ambient Temperature vs. Chromaticity Coordinate

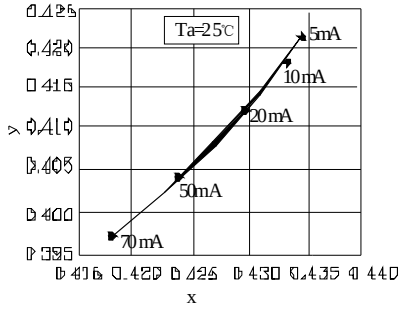


Fig.9 Forward Current vs. Chromaticity Coordinate

Bin Code List

Tolerance of each bin are±10%

Luminous Intensity(IV),Unit:mcd@20mA					
Iv bin code(main code)			Iv bin code(sub code-2)		
Bin Code	MIN	Max	Bin Code	MIN	Max
H12	1400	1550	H121	1400	1450
H13	1550	1700	H122	1450	1500
H14	1700	1900	H123	1500	1550
			H131	1550	1600
			H132	1600	1650
			H133	1650	1700
			H141	1700	1750
			H142	1750	1800
			H143	1800	1850
			H144	1850	1900

Tolerance of each bin are±0.1V.

Forward Voltage(VF), Unit:V@20mA		
Bin Code	MIN	Max
14	2.90	3.00
15	3.00	3.10
16	3.10	3.20
17	3.20	3.30
18	3.30	3.40
19	3.40	3.50

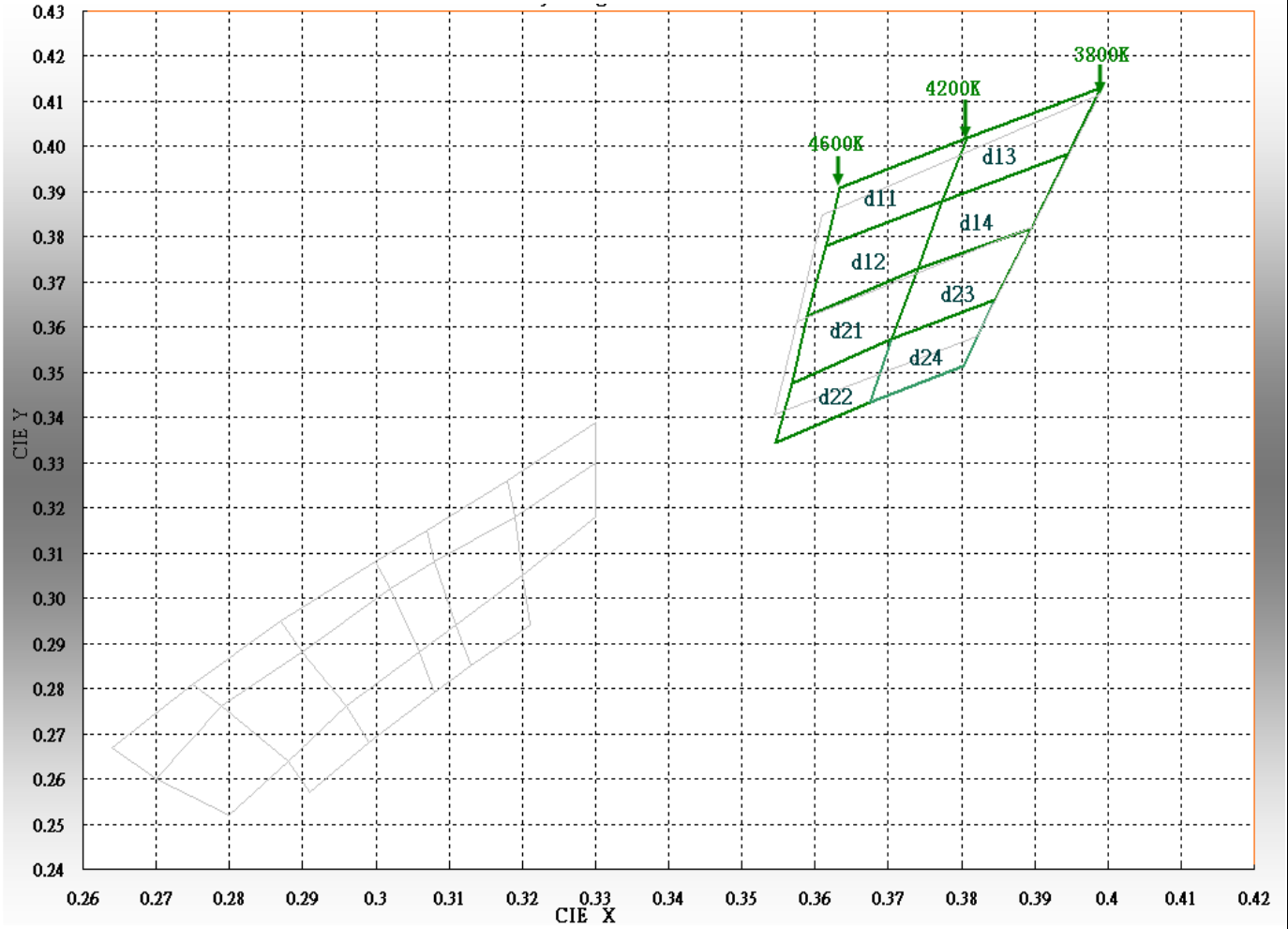
Color Rank (CIE chromaticity x , y) @ 20mA

Rank **d11**				
x	0.3634	0.3615	0.3774	0.3807
y	0.3910	0.3780	0.3878	0.4020
Rank d12				
x	0.3615	0.3590	0.3740	0.3774
y	0.3780	0.3625	0.3730	0.3878
Rank d13				
x	0.3807	0.3774	0.3945	0.3988
y	0.4020	0.3878	0.3982	0.4116
Rank d14				
x	0.3774	0.3740	0.3897	0.3945
y	0.3878	0.3730	0.3823	0.3982

Rank d21				
x	0.3590	0.3568	0.3705	0.3740
y	0.3625	0.3475	0.3573	0.3730
Rank d22				
x	0.3568	0.3547	0.3675	0.3705
y	0.3475	0.3345	0.3435	0.3573
Rank d23				
x	0.3740	0.3705	0.3846	0.3897
y	0.3730	0.3573	0.3660	0.3823
Rank d24				
x	0.3705	0.3675	0.3803	0.3846
y	0.3573	0.3435	0.3515	0.3660

＊ Measurement of Color coordinates : +/- 0.01

C.I.E Chromaticity Diagram



Label Explanation

CUS. PART NO: To be denominated.

CUSTOMER: To be denominated.

PART NO: Refer to P16

IV--- Luminous Intensity Code

VF--- Forward Voltage Code

CIE--- Color Rank Code

LOT NO: E L P 7 8 0001

A B C D E F

A---E: For series number

B---L: Local F: Foreign

C---P: PLCC SMD

D---Year

E---Month

F---SPEC.

PACKING QUANTITY OF BAG :

2000pcs Max for T670 series

2000pcs Max for T650 series

2000pcs Max for S020 series

2000pcs Max for T677 series

DATE CODE：2007 08 02

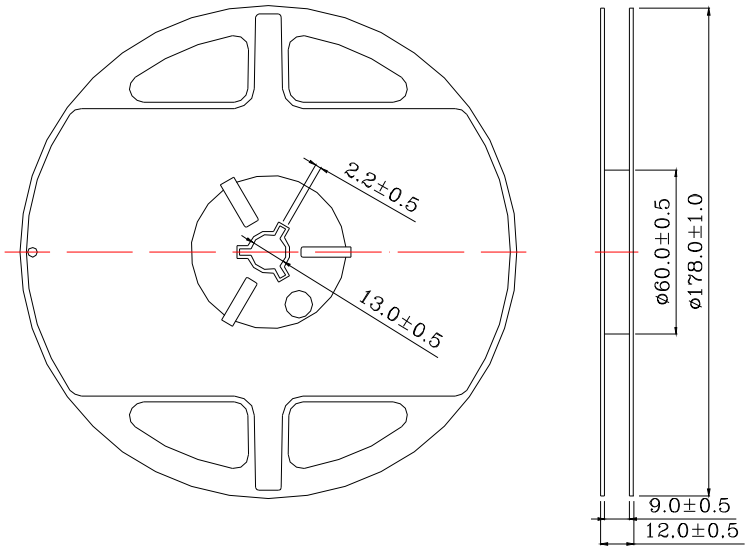
G H I

G--- Year

H--- Month

I --- Day

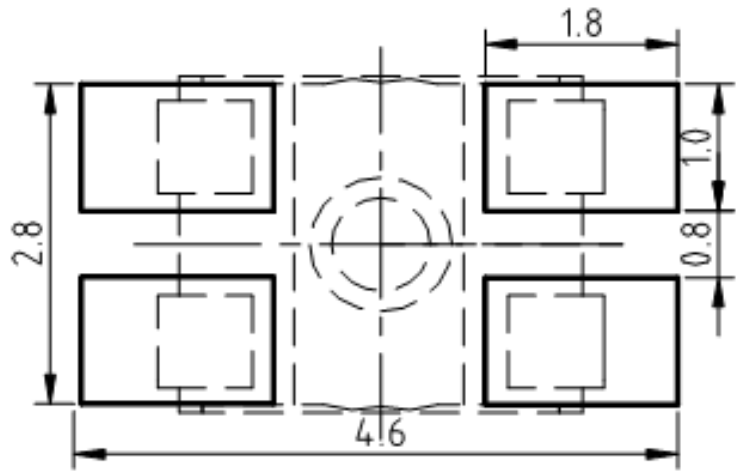
Reel Dimensions



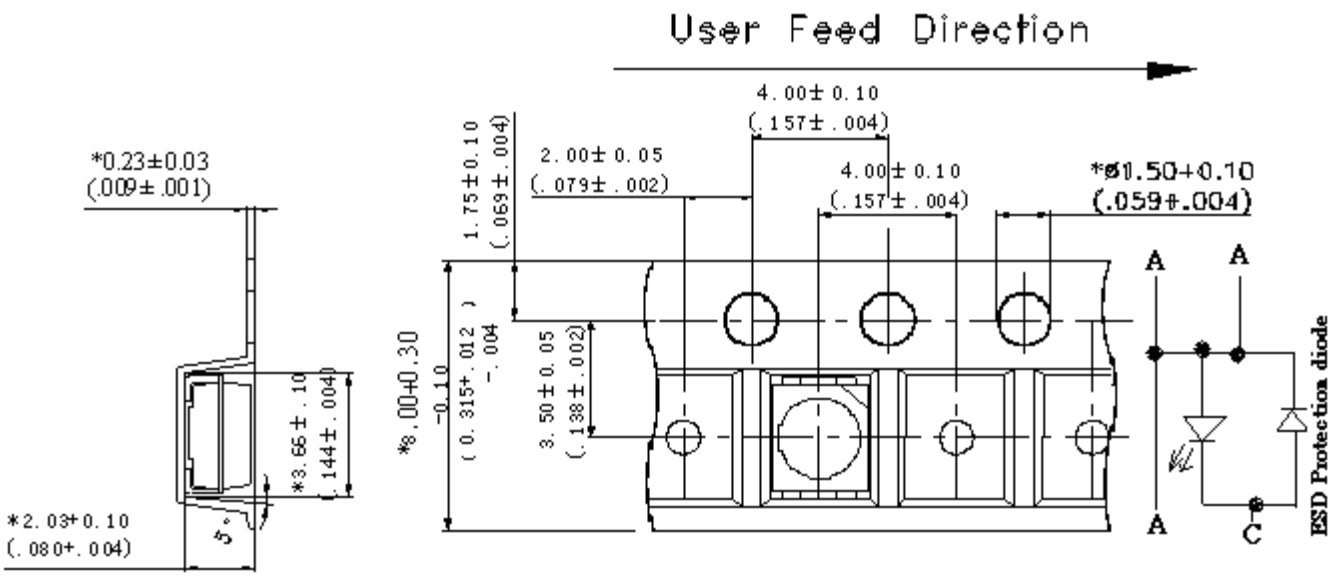
Notes:

1. Taping Quantity : 2000pcs MAX
2. The tolerances unless noted is±0.1mm, Angle±0.5°, Unit: mm.

Suggest Soldering Pad Dimensions

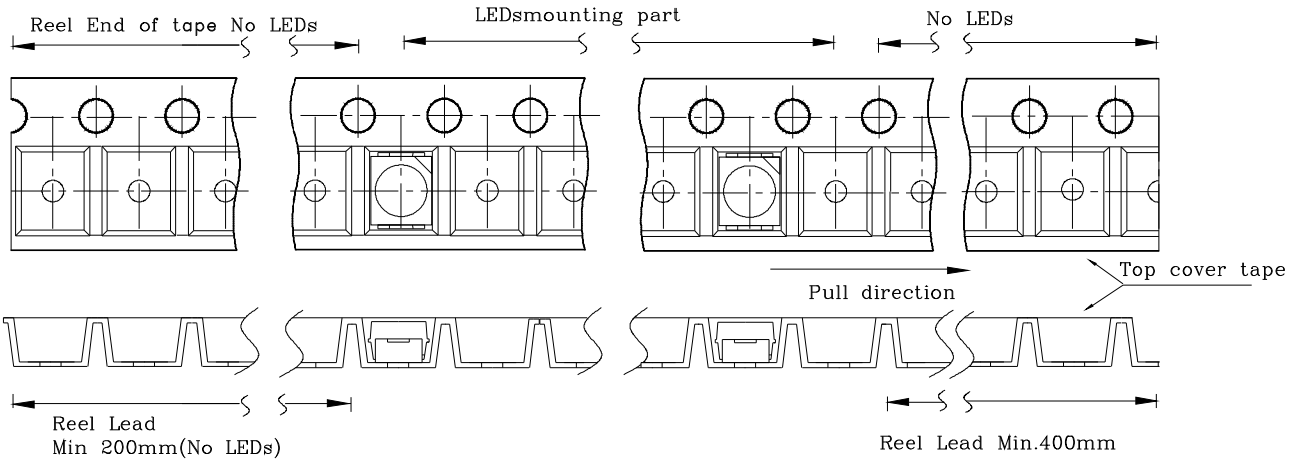


Package Dimensions Of Tape And Reel

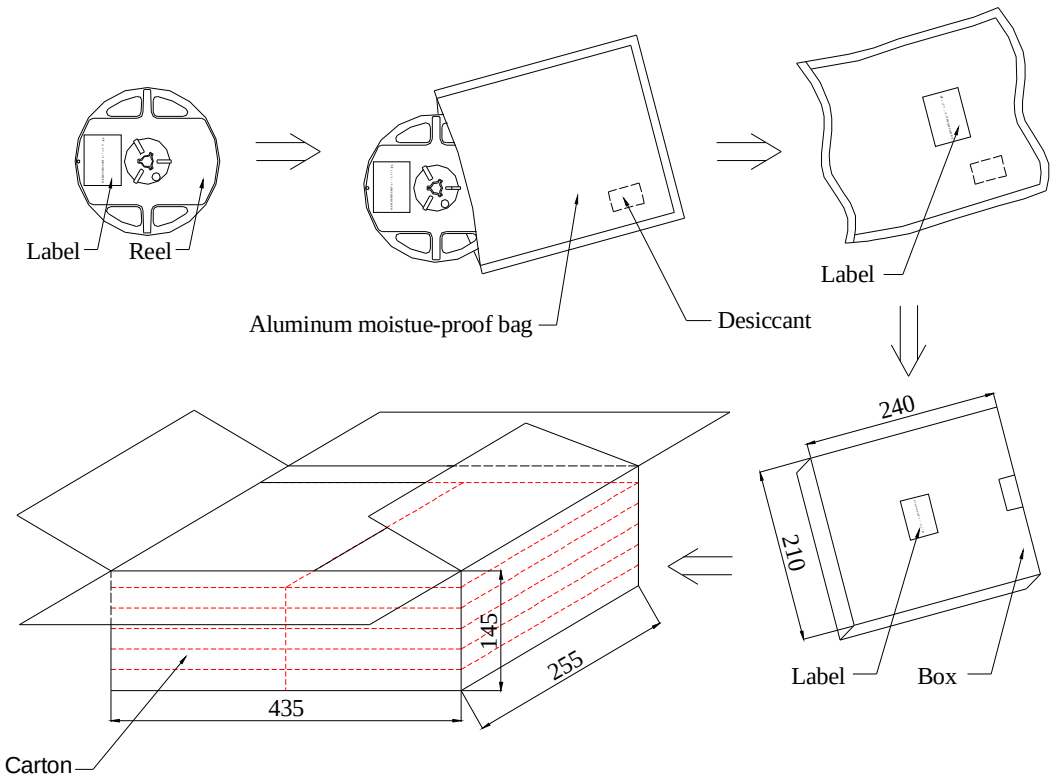


Notes: All dimensions are in millimeters.

Packaging Of Electronic Components On Continuous Tapes



Moisture Resistant Packaging

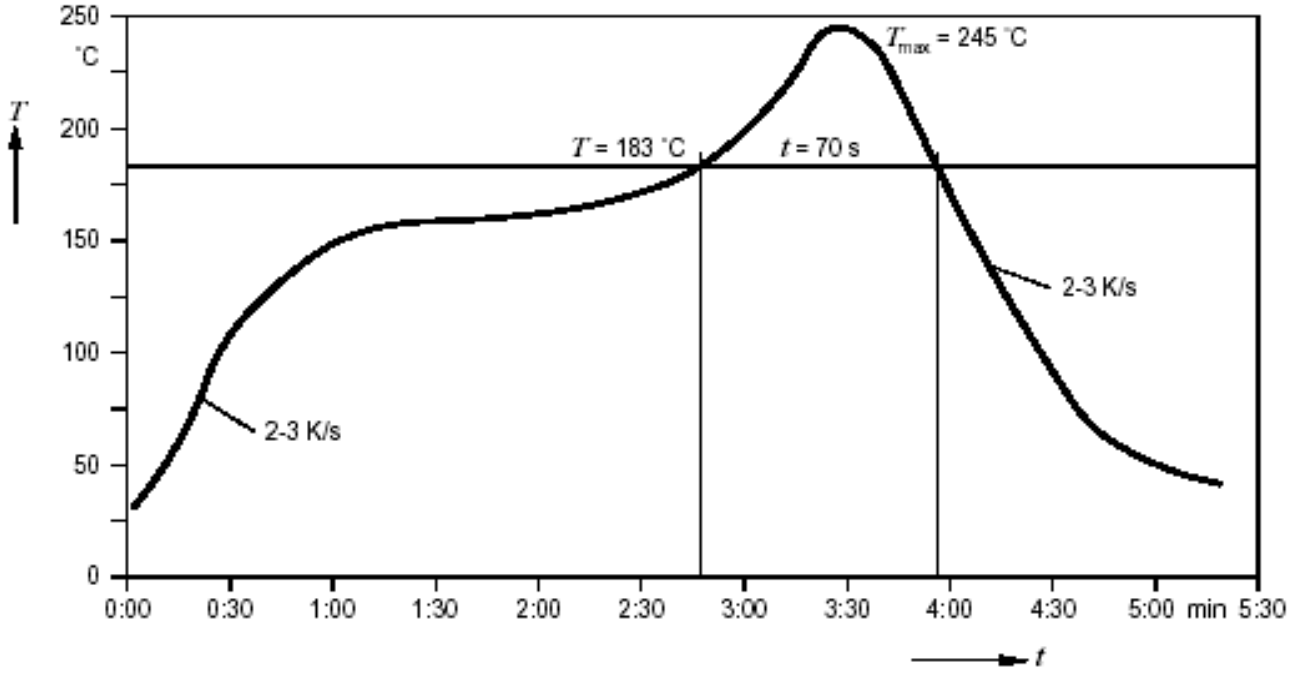


Notes : One reel in a bag, one bag in a inner box, ten inner boxes in a carton. Unit : mm.

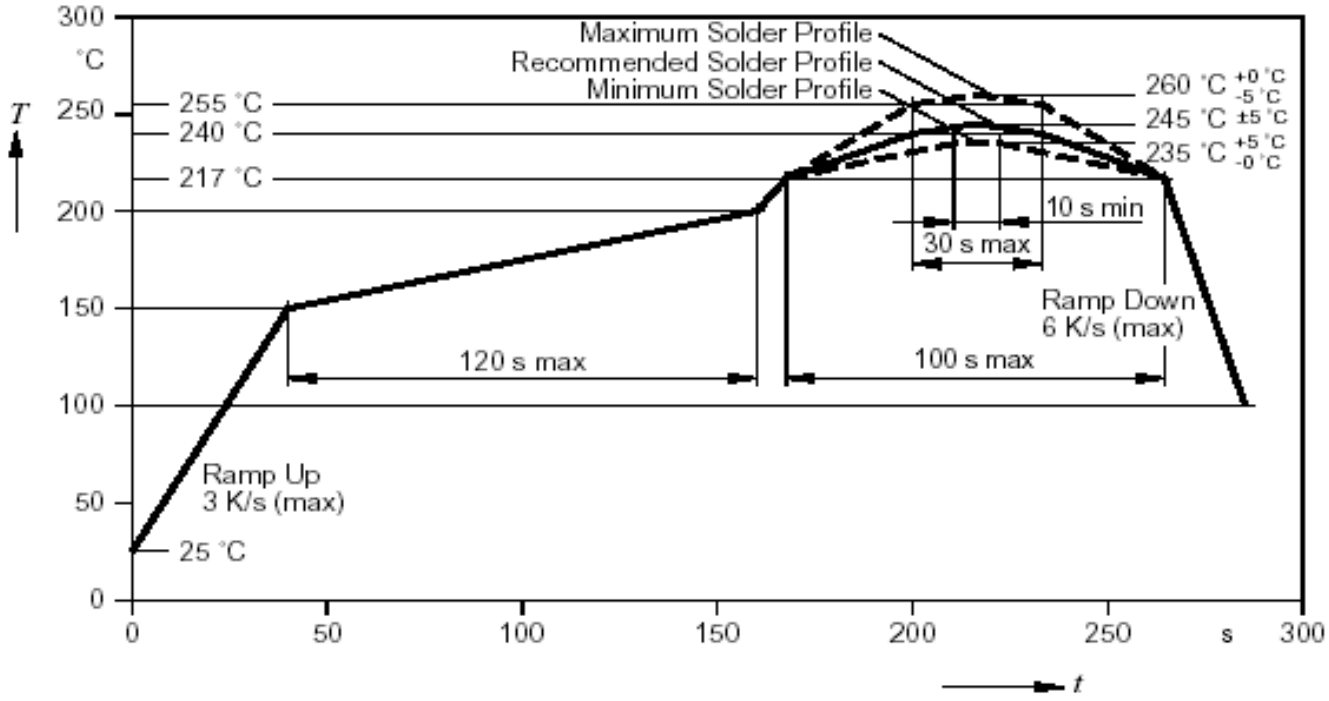
Cleaning

- If cleaning is required , use the following solutions for less than 1 minute and less than 40℃.
- Appropriate chemicals: isopropyl alcohol. (When using other solvents, it should be confirmed beforehand whether the solvents will dissolve the package and the resin or not.)
- Effect of ultrasonic cleaning on the LED resin body differs depending on such factors as ultrasonic power and the assembled condition. Before cleaning, a pre-test should be confirm whether any damage to the LEDS will occur.

- Suggest Sn/Pb IR Reflow Soldering Profile Condition:



- Suggest Pb-Free IR Reflow Soldering Profile Condition:



I CAUTIONS

1. Static Electricity:

* Static electricity or surge voltage damages the LEDs.
It is recommended that a wrist band or an anti-electrostatic glove be used when handling the LEDs.
* All devices, equipment and machinery must be properly grounded.
It is recommended that measures be taken against surge voltage to the equipment that mounts the LEDs.
* When inspecting the final products in which LEDs were assembled, it is recommended to check whether the assembled LEDs are damaged by static electricity or not. It is easy to find static-damaged LEDs by a light-on test or a VF test at a lower current (blew 1mA is recommended).
* Damaged LEDs will show some unusual characteristics such as the leak current remarkably increases, the forward voltage becomes lower, or the LEDs do not light at the low current.
Criteria: (VF>2.0V,at IF=0.5m A)

2. Storage :

* Before opening the package :
The LEDs should be kept at 30℃ or less and 85%RH or less. When storing the LEDs, moisture proof packaging with absorbent material (silica gel) is recommended.
* After opening the package :
The LEDs should be kept at 30℃ or less and 70%RH or less. The LEDs should be soldered within 168 hours (7 days) after opening the package. If unused LEDs remain, they should be stored in moisture proof packages, such as sealed containers with packages of moisture absorbent material (silica gel). It is also recommended to return the LEDs to the original moisture poof bag and to reseal the moisture proof bag again.
If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should e performed using the following conditions.
Baking treatment: more than 24hours at 65±5℃.
* Please avoid rapid transitions in ambient temperature in high humidity environments where condensation may occur.

3. Soldering:

Do not apply any stress to the LED lens during soldering while the LED is at high temperature.
Recommended soldering condition.

* Reflow Soldering :

Pre-heat 120~150°C, 120sec. MAX., Peak temperature : 240°C Max. Soldering time : 10 sec Max.

* Soldering Iron : (Not recommended)

Temperature350°C Max., Soldering time : 3 sec. Max.(one time only), power dissipation of iron : 20W Max. use SN60 solder of solder with silver content and don't to touch LED lens when soldering.

4. Lead-Free Soldering

For Reflow Soldering :

1、Pre-Heat Temp: 150-180℃,120sec.Max.

2、Soldering Temp: Temperature Of Soldering Pot Over 240℃,40sec.Max.

3、Peak Temperature: 260℃ ，10sec.

4、Reflow Repetition: 2 Times Max.

5、Suggest Solder Paste Formula : 93.3 Sn/3.1 Ag/3.1 Bi/0.5 Cu

For Soldering Iron (Not Recommended) :

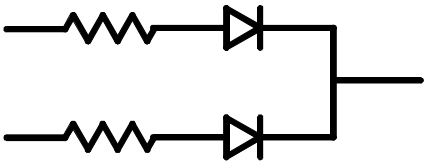
1、Iron Tip Temp: 350℃ Max.

2、Soldering Iron: 30w Max.

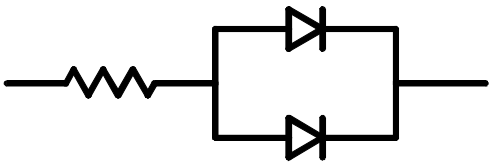
3、Soldering Time: 3 Sec. Max. One Time.

5. Drive Method

Circuit model A



Circuit model B



(A)Recommended circuit.

(B)The difference of brightness between LED`s could be found due to the Vf-If characteristics of LED.

6. Reliability

1、Criteria For Judging The Damage

Item	Symbol	Test Conditions	Criteria for Judgement	
			MIN.	Max.
Forward Voltage	VF	IF=20mA	-	U.S.L.*)×1.1
Reverse Current	IR	VR=5V	-	U.S.L.*)×2.0
Luminous Intensity	IV	IF=20mA	L.S.L**)×0.7	-

***)** U.S.L.: Upper Standard Level

**) L.S.L: Lower Standard Level

2、Test Items And Results

Test Item	Reference Standard	Test Condition	Note	Number of Damaged
Resistance to Soldering Heat (Reflow Soldering)	JEITA ED-4701300 301	Tsld=260℃,10sec. (Pre treatment 30 ℃,70%,168hrs)	2times	0/50
Solder ability (Reflow Soldering)	JEITA ED-4701300 303	Tsld=215℃,3sec. (Lead Solder)	1time over 95%	0/50
Thermal Shock	JEITA ED-4701300 307	-40℃ ~ 100℃ 30min. 30min.	100cycles	0/50
Temperature Cycle	JEITA ED-4701100 105	-40℃ ~ 25℃~100℃~25℃ 30min. 5min. 30min. 5min	100cycles	0/50
High Temperature Storage	JEITA ED-4701200-201	Ta=100℃	1000hrs.	0/50
Temperature Humidity Storage	JEITA ED-4701100 103	Ta=60℃,RH=90%	1000hrs.	0/50
Low Temperature Storage	JEITA ED-4701200 202	Ta=-40℃	1000hrs.	0/50
Steady State Operating Life Condition		Ta=25℃,IF=20mA	1000hrs.	0/50
Steady State Operating Life of High Temperature		Ta=85℃,IF=5mA	500hrs.	0/50
Steady State Operating Life of High Humidity Heat		Ta=60℃,RH=90%,IF=15mA	500hrs.	0/50
Steady State Operating Life of Low Temperature		Ta=-30℃,IF=20mA	500hrs.	0/50

7.Others:

The appearance and specifications of the product may be modified for improvement without notice.

PART NO. SYSTEM :

L – T 677 W D T Z – U1

- U1 : Special code for USA Sales customer
- Z: with Zener diode
- T : Taping for 7 inch reel
- Lens color
  D : Color Diffused
- Emitting color:
  W : InGaN + YAG White color
- Lead frame type:
  677:3528 PLCC4 series (SMD6723)
- T: PLCC Top View Type
- L:PARA LIGHT

PARA LIGHT ELECTRONICS CO., LTD.
4F, No.1, Lane 93, Chien Yi Road, Chung Ho City, Taipei, Taiwan
Tel: 886-2-2225-3733 Fax: 886-2-2225-4800
E-mail: para@para.com.tw http://www.para.com.tw

DATA SHEET

PART NO.: L-T677WDTZ-U1

REV: A / 3

CUSTOMER'S APPROVAL : _____ DCC : _____

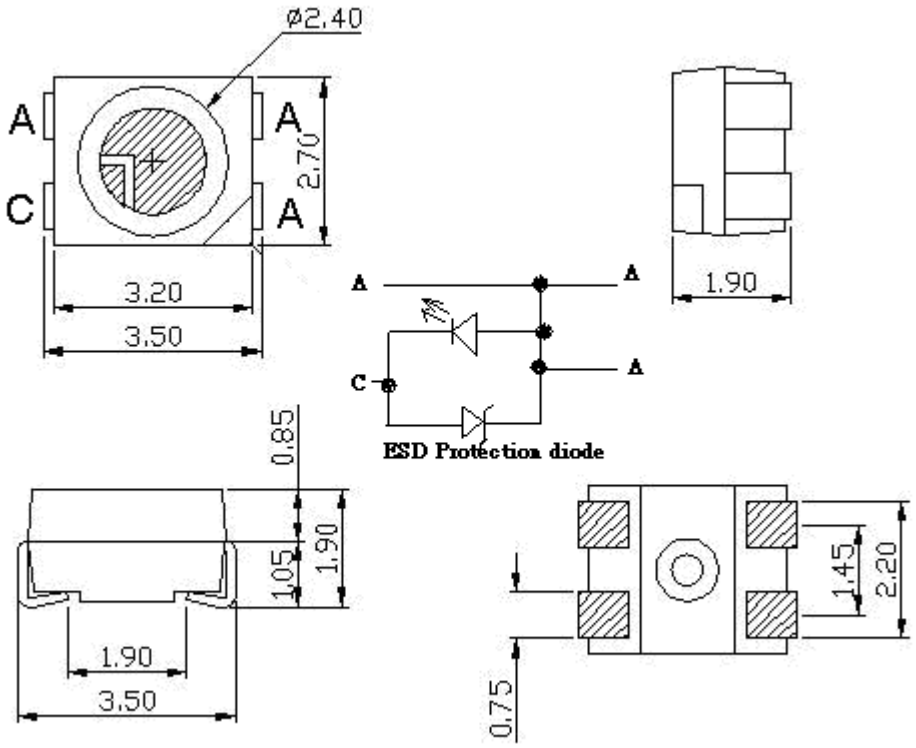
Features

- Top view, Wide view angle, White color PLCC4 package SMD LED .
- EIA STD package, packing in 8mm tape on 7" diameter reels (ANSI/EIA-481-B-2001).
- Compatible with automatic Pick & Place equipment.
- Compatible with IR Reflow soldering and TTW soldering.
- Pb free product and acceptable lead-free process!
- Meet RoHS Green Product.
- PARA LIGHT LED match with the spec of PWI part spec# 5800027-089 white LED.

Application

- Reading Lamps, Substitution of Micro Incandescent Lamps, Marker Lights.
- Emergency lighting / Signal and symbol luminaries.

Package Outline Dimensions



Notes:

1. All dimensions are in millimeters.
2. Tolerance is ± 0.10mm (.004") unless otherwise noted.

Chip Materials

- ＊ Dice Material : InGaN
- ＊ Light Color : White
- ＊ Lens Color : Light Yellow Diffused.

Absolute Maximum Ratings(Ta=25℃)

Symbol	Parameter	Rating	Unit
P_D	Power Dissipation	75	mW
I_{PF}	Peak Forward Current (1/10 Duty Cycle, 0.1ms Pulse Width)	100	mA
I_F	Continuous Forward Current	20	mA
V_R	Reverse Voltage	5	V
ESD	Electrostatic Discharge Threshold (HBM)Note A	2000	V
Topr	Operating Temperature Range	-40 ~ + 85	℃
Tstg	Storage Temperature Range	-40 ~ + 100	℃

Note A :

HBM : Human Body Model. Seller gives no other assurances regarding the ability of to withstand ESD.

Electro-Optical Characteristics (Ta=25℃)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test Condition
Luminous Intensity	IV	2100	2600		mcd	IF=20mA
Viewing Angle	2θ1/2		120		Deg	Note 2
CIE Chromaticity	x		0.3700			IF=20mA
CIE Chromaticity	y		0.3700			
Forward Voltage	VF	2.80	3.20	3.50	V	IF = 20mA
Color Temperature	Kelvin	3800		4600	K	IF = 20mA

Notes:

1. Luminous intensity is measured with a light sensor and filter combination that proximities the CIE eye-response curve.
2. θ 1/2 is the off-axis angle at which the luminous intensity is half the axial luminous intensity.
3. Caution in ESD :
   Static Electricity and surge damages the LED. It is recommended use a wrist band or anti-electrostatic glove when handling the LED. All devices, equipment and machinery must be properly grounded.
4. Major standard testing equipment by “Instrument System” Model : CAS140B Compact Array Spectrometer and “KEITHLEY” Source Meter Model : 2400.

● Typical Electro-Optical Characteristics Curves

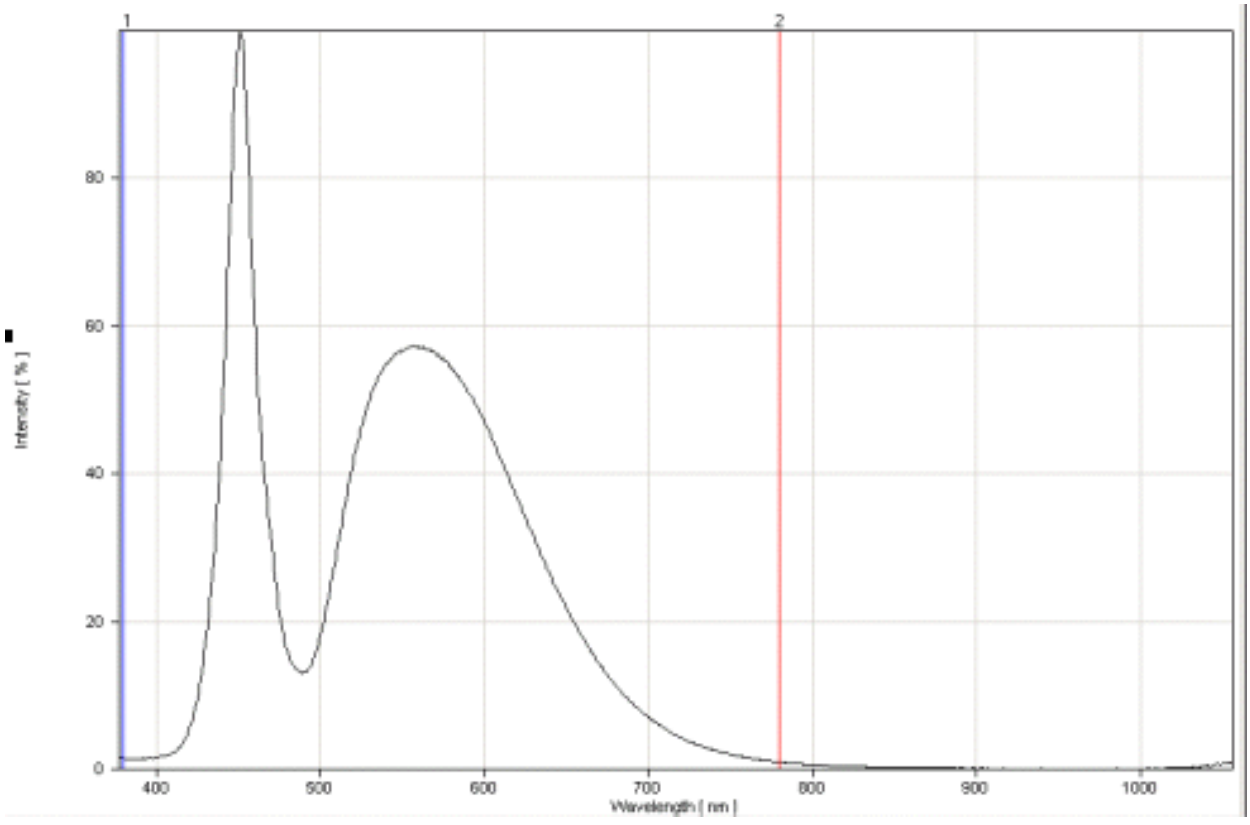


Fig.1 Relative Intensity vs. Wavelength

● Typical Electro-Optical Characteristics Curves

(25℃ Ambient Temperature Unless Otherwise Noted)

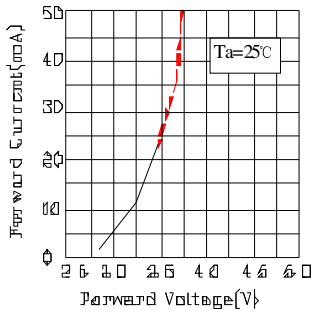


Fig.1 Forward Current vs.Forward Voltage

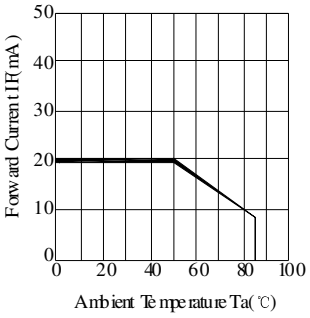


Fig.2 Forward Current Derating Curve

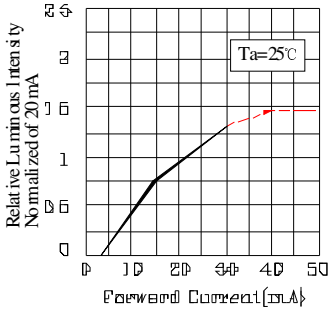


Fig.3 Relative Luminous Intensity vs.Forward Current

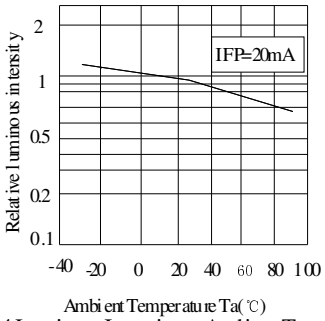


Fig.4 Luminous Intensity vs.Ambient Temperature

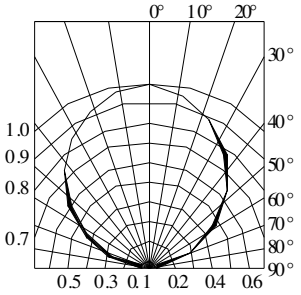


Fig.5 Spatial Distribution

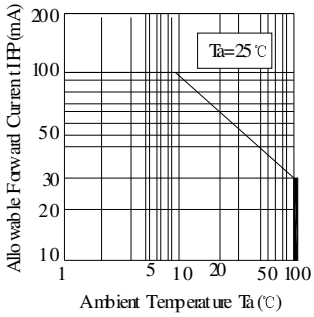


Fig.6 Forward Current Derating Curve

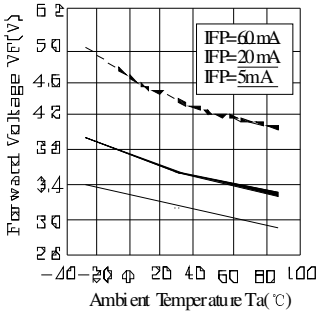


Fig.7 Ambient Temperature vs.Forward Voltage

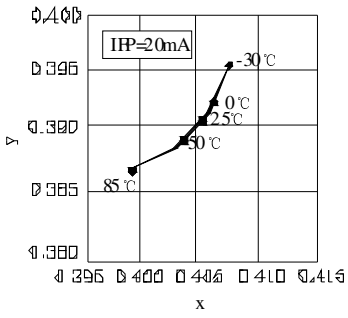


Fig.8 Ambient Temperature vs.Chromaticity Coordinate

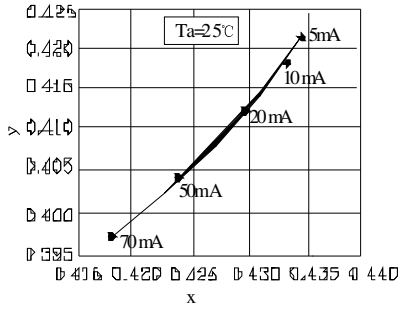


Fig.9 Forward Current vs.Chromaticity Coordinate

Bin Code List

Tolerance of each bin are ± 10%

Luminous Intensity(IV),Unit:mcd@20mA						
Iv bin code(main code)				Iv bin code(sub code-2)		
Bin Code	MIN	Max		Bin Code	MIN	Max
H16	2100	2350		H152	2000	2100
H17	2350	2600		H161	2100	2200
H18	2600	2900		H162	2200	2350
H19	2900	3250		H171	2350	2500
				H172	2500	2600
				H181	2600	2750
				H182	2750	2900
				H191	2900	3100
				H192	3100	3250

Tolerance of each bin are ± 0.1V.

Forward Voltage(VF), Unit:V@20mA		
Bin Code	MIN	Max
13	2.80	2.90
14	2.90	3.00
15	3.00	3.10
16	3.10	3.20
17	3.20	3.30
18	3.30	3.40
19	3.40	3.50

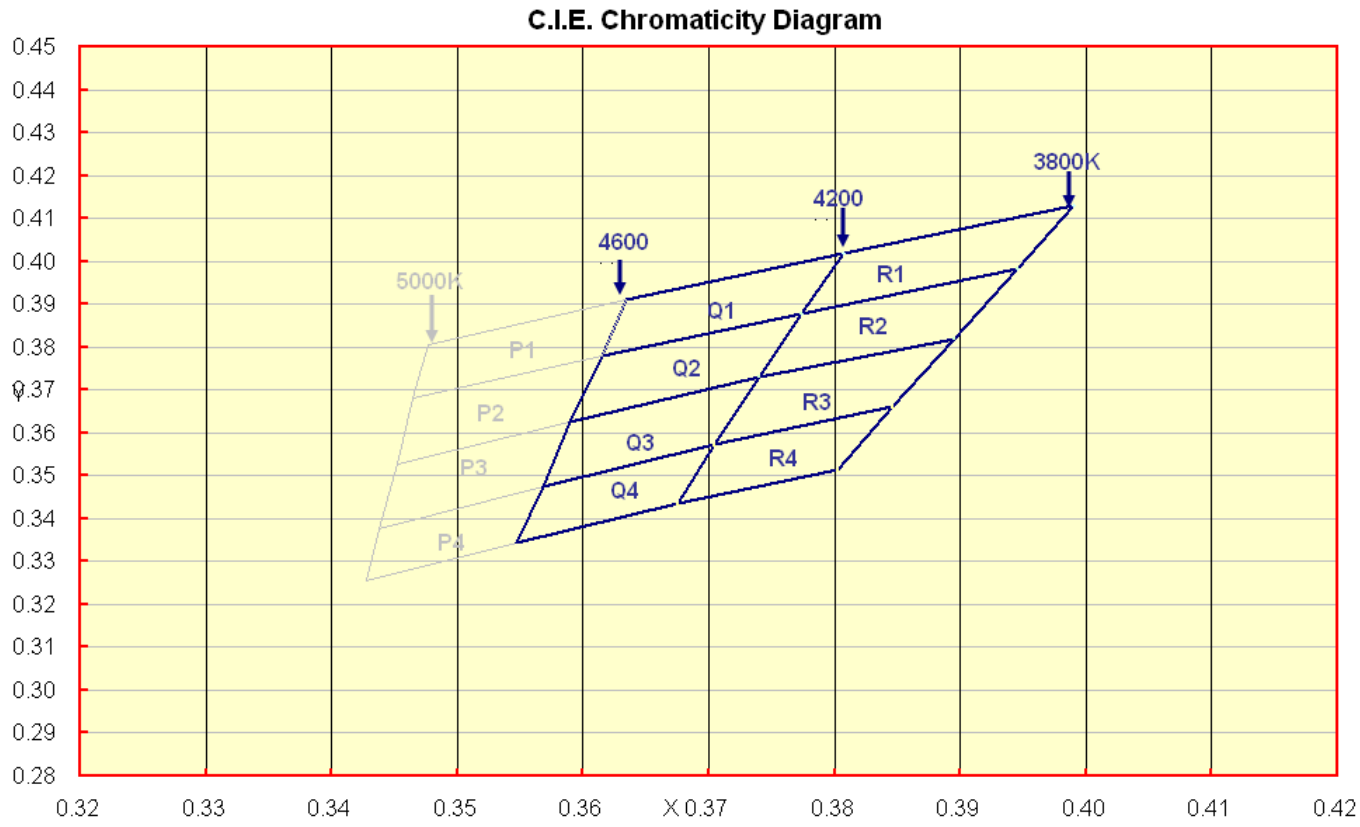
Color Rank (CIE chromaticity x , y) @ 20mA

Rank Q1				
x	0.3634	0.3615	0.3774	0.3807
y	0.3910	0.3780	0.3878	0.4020
Rank Q2				
x	0.3615	0.3590	0.3740	0.3774
y	0.3780	0.3625	0.3730	0.3878
Rank R1				
x	0.3807	0.3774	0.3945	0.3988
y	0.4020	0.3878	0.3982	0.4116
Rank R2				
x	0.3774	0.3740	0.3897	0.3945
y	0.3878	0.3730	0.3823	0.3982

Rank Q3				
x	0.3590	0.3568	0.3705	0.3740
y	0.3625	0.3475	0.3573	0.3730
Rank Q4				
x	0.3568	0.3547	0.3675	0.3705
y	0.3475	0.3345	0.3435	0.3573
Rank R3				
x	0.3740	0.3705	0.3846	0.3897
y	0.3730	0.3573	0.3660	0.3823
Rank R4				
x	0.3705	0.3675	0.3803	0.3846
y	0.3573	0.3435	0.3515	0.3660

＊ Measurement of Color coordinates : +/- 0.01

- C.I.E Chromaticity Diagram



● Label Explanation

CUS. PART NO: To be denominated.

CUSTOMER: To be denominated.

PART NO: Refer to P16

IV--- Luminous Intensity Code

VF--- Forward Voltage Code

CIE--- Color Rank Code

LOT NO: E L P 7 8 0001

A B C D E F

A---E: For series number

B---L: Local F: Foreign

C---P: PLCC SMD

D---Year

E---Month

F---SPEC.

PACKING QUANTITY OF BAG :

2000pcs Max for T670 series

2000pcs Max for T650 series

2000pcs Max for S020 series

1000pcs min&2000pcs max for T677 series

DATE CODE: 2007 08 02

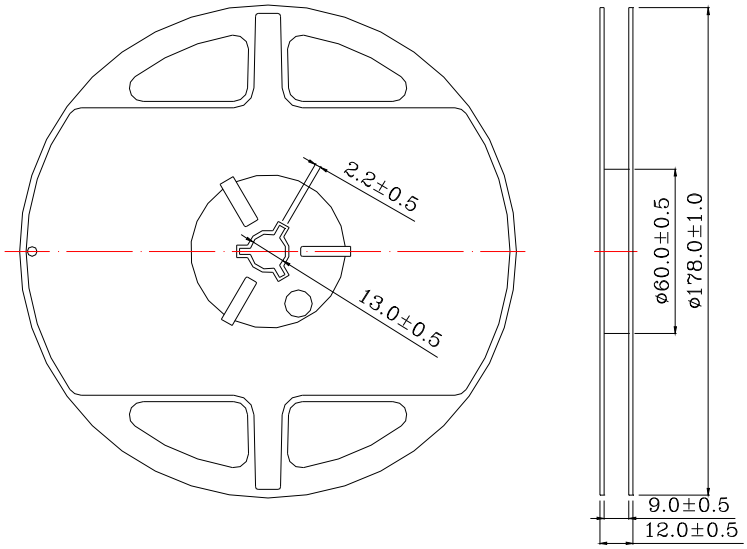
G H I

G--- Year

H--- Month

I --- Day

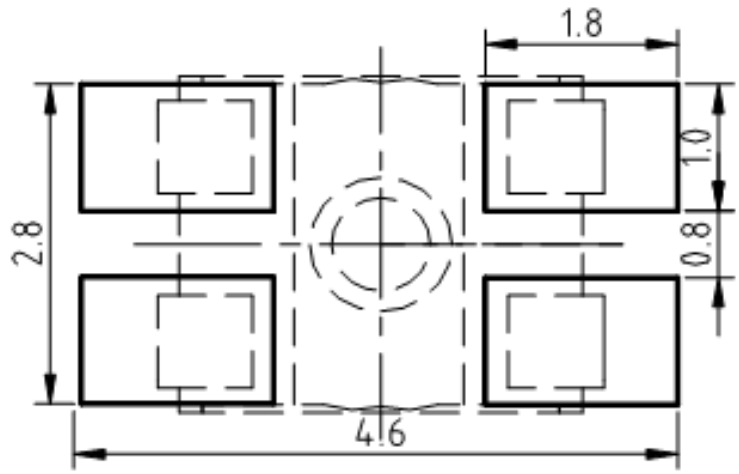
- Reel Dimensions



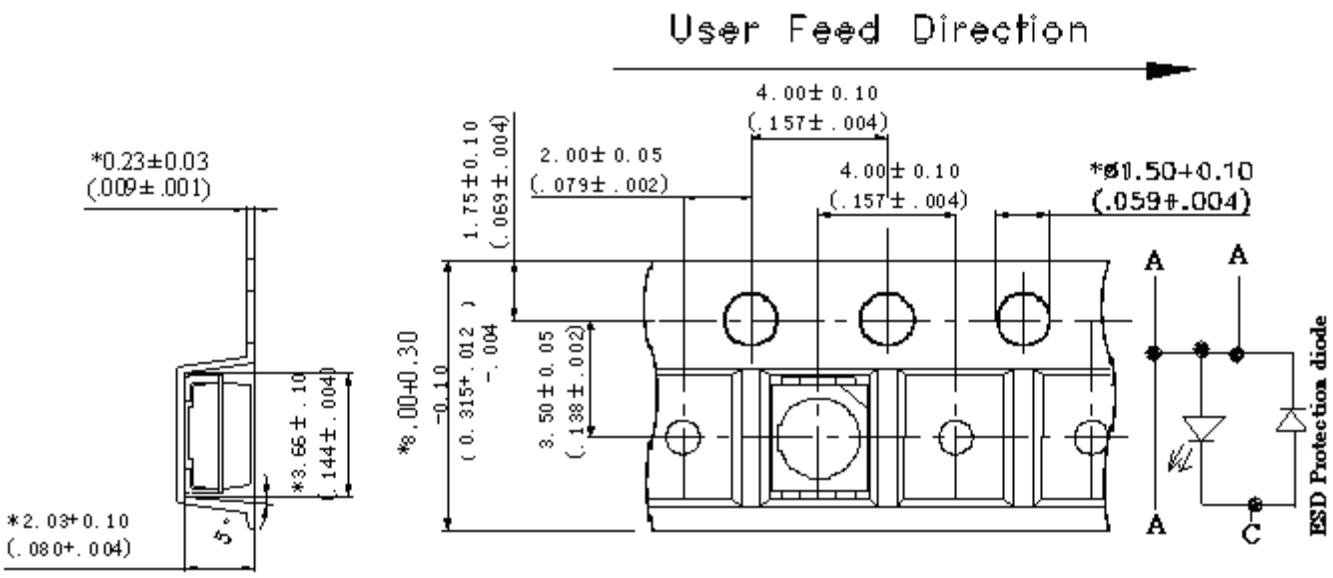
Notes:

1. Taping Quantity : 1000pcs /1500pcs/2000pcs
2. The tolerances unless noted is±0.1mm, Angle±0.5° , Unit: mm.

- Suggest Soldering Pad Dimensions

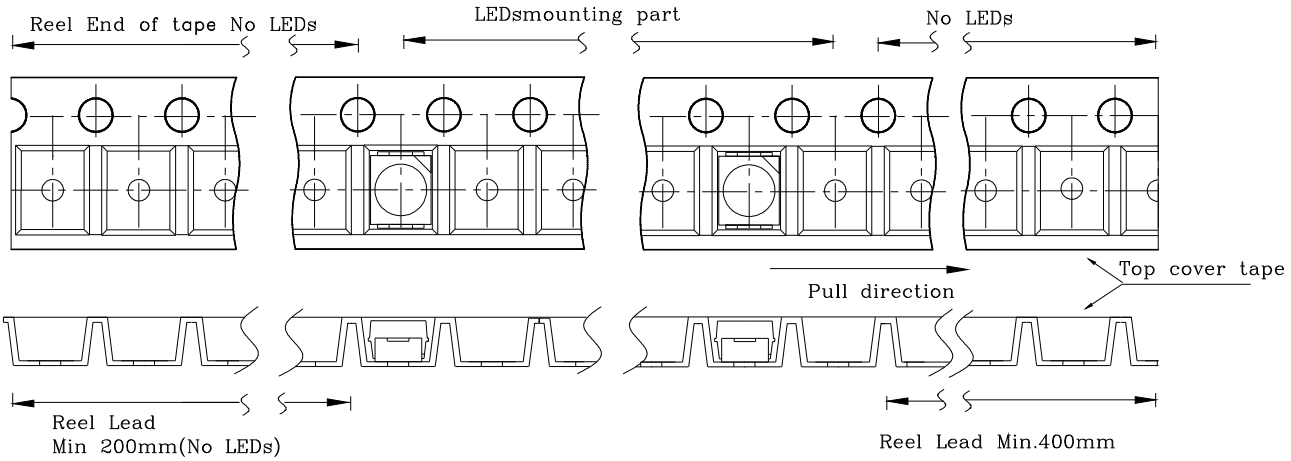


- Package Dimensions Of Tape And Reel

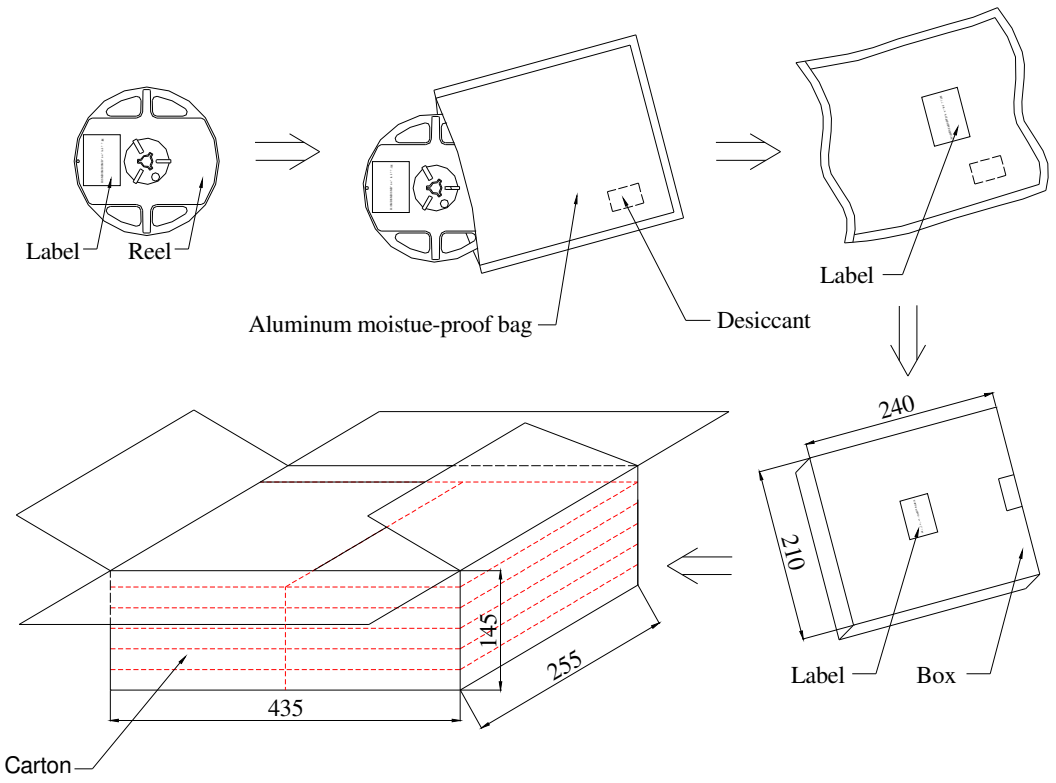


Notes: All dimensions are in millimeters.

- Packaging Of Electronic Components On Continuous Tapes



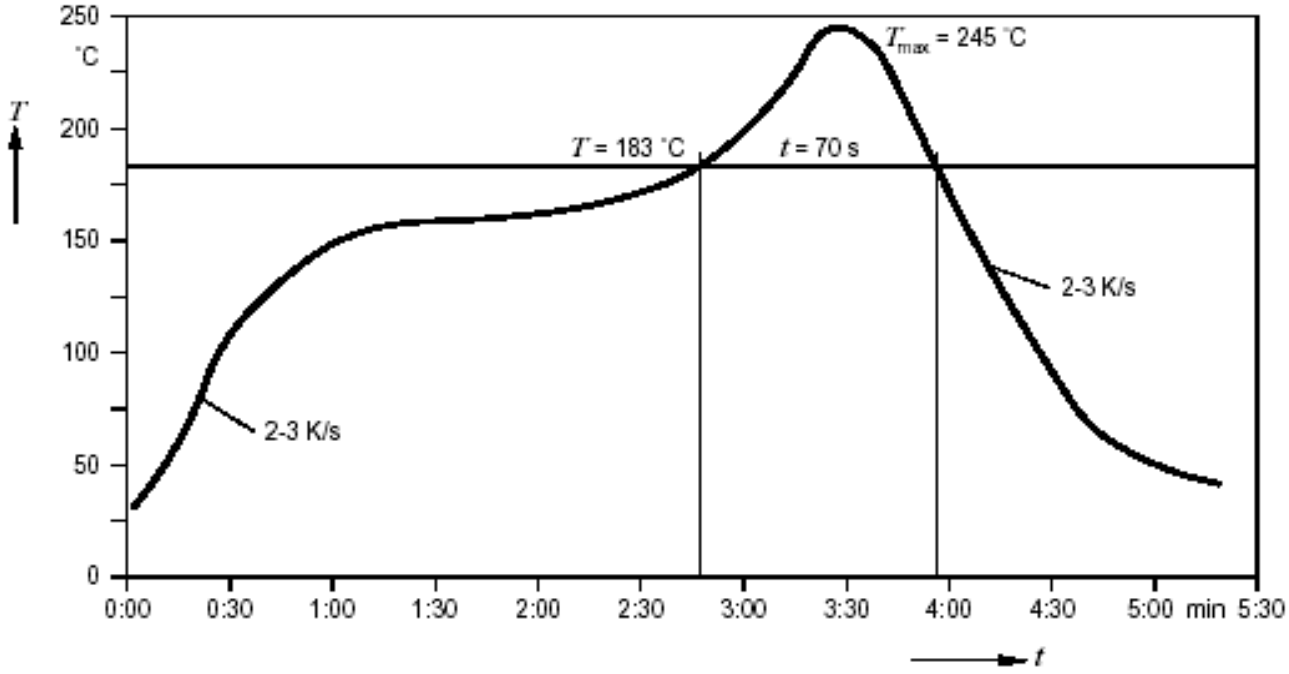
- Moisture Resistant Packaging



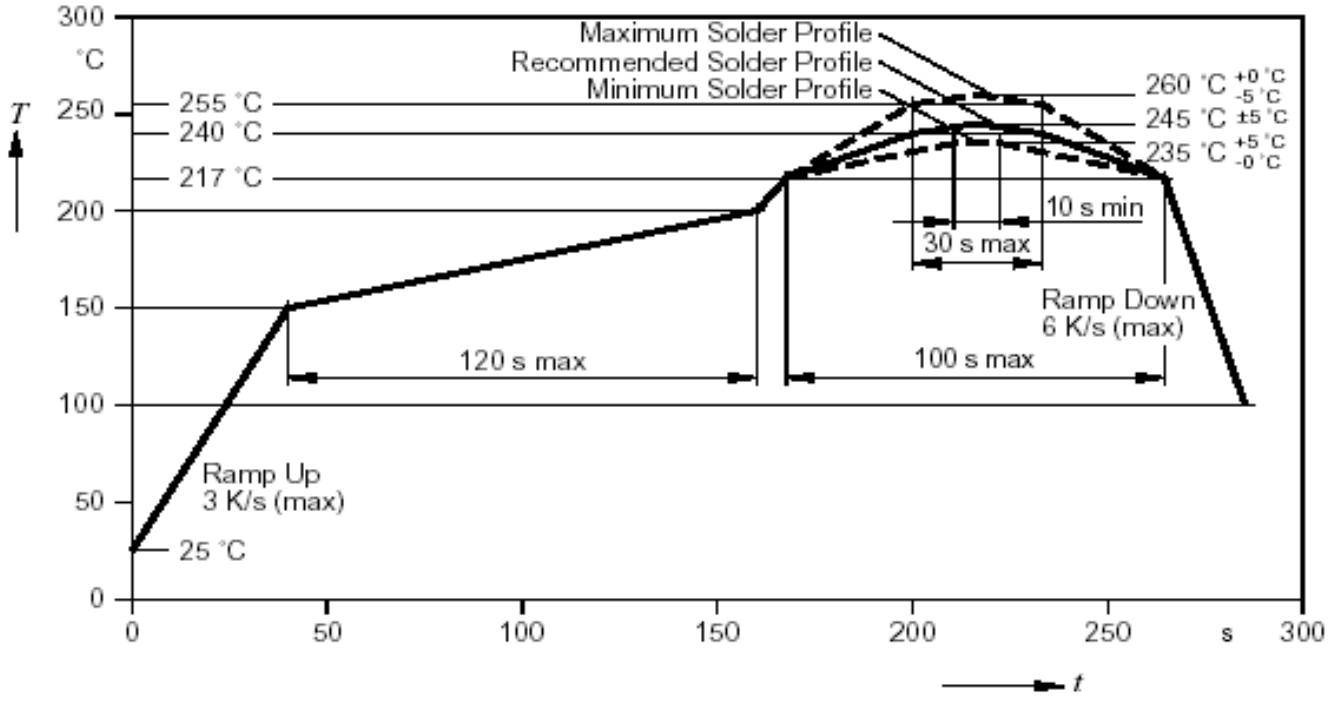
Notes : One reel in a bag, one bag in a inner box, ten inner boxes in a carton. Unit : mm.

- Cleaning
  - ＊ If cleaning is required , use the following solutions for less than 1 minute and less than 40℃.
  - ＊ Appropriate chemicals: isopropyl alcohol. (When using other solvents, it should be confirmed beforehand whether the solvents will dissolve the package and the resin or not.)
  - ＊ Effect of ultrasonic cleaning on the LED resin body differs depending on such factors as ultrasonic power and the assembled condition. Before cleaning, a pre-test should be confirm whether any damage to the LEDS will occur.

- Suggest Sn/Pb IR Reflow Soldering Profile Condition:



- Suggest Pb-Free IR Reflow Soldering Profile Condition:



● CAUTIONS

1. Static Electricity:

* Static electricity or surge voltage damages the LEDs.
It is recommended that a wrist band or an anti-electrostatic glove be used when handling the LEDs.
* All devices, equipment and machinery must be properly grounded.
It is recommended that measures be taken against surge voltage to the equipment that mounts the LEDs.
* When inspecting the final products in which LEDs were assembled, it is recommended to check whether the assembled LEDs are damaged by static electricity or not. It is easy to find static-damaged LEDs by a light-on test or a VF test at a lower current (blew 1mA is recommended).
* Damaged LEDs will show some unusual characteristics such as the leak current remarkably increases, the forward voltage becomes lower, or the LEDs do not light at the low current.
Criteria: (VF>2.0V,at IF=0.5m A)

2. Storage :

* Before opening the package :
The LEDs should be kept at 30°C or less and 85%RH or less. When storing the LEDs, moisture proof packaging with absorbent material (silica gel) is recommended.
* After opening the package :
The LEDs should be kept at 30°C or less and 70%RH or less. The LEDs should be soldered within 168 hours (7 days) after opening the package. If unused LEDs remain, they should be stored in moisture proof packages, such as sealed containers with packages of moisture absorbent material (silica gel). It is also recommended to return the LEDs to the original moisture poof bag and to reseal the moisture proof bag again.
If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should e performed using the following conditions.
Baking treatment: more than 24hours at 65±5℃.
* Please avoid rapid transitions in ambient temperature in high humidity environments where condensation may occur.

3. Soldering:

Do not apply any stress to the LED lens during soldering while the LED is at high temperature.
Recommended soldering condition.
* Reflow Soldering :
Pre-heat 120~150°C, 120sec. MAX., Peak temperature : 240°C Max. Soldering time : 10 sec Max.
* Soldering Iron : (Not recommended)
Temperature350°C Max., Soldering time : 3 sec. Max.(one time only), power dissipation of iron : 20W Max. use SN60 solder of solder with silver content and don't to touch LED lens when soldering.

4. Lead-Free Soldering

For Reflow Soldering :

1、Pre-Heat Temp: 150-180℃,120sec.Max.

2、Soldering Temp: Temperature Of Soldering Pot Over 240℃,40sec.Max.

3、Peak Temperature: 260℃ ，10sec.

4、Reflow Repetition: 2 Times Max.

5、Suggest Solder Paste Formula : 93.3 Sn/3.1 Ag/3.1 Bi/0.5 Cu

For Soldering Iron (Not Recommended) :

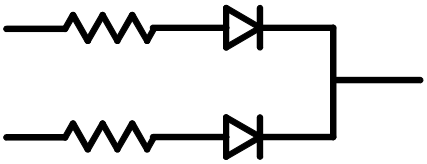
1、Iron Tip Temp: 350℃ Max.

2、Soldering Iron: 30w Max.

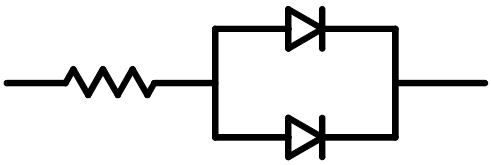
3、Soldering Time: 3 Sec. Max. One Time.

5. Drive Method

Circuit model A



Circuit model B



(A)Recommended circuit.

(B)The difference of brightness between LED`s could be found due to the Vf-If characteristics of LED.

6. Reliability

1、Criteria For Judging The Damage

Item	Symbol	Test Conditions	Criteria for Judgement	
			MIN.	Max.
Forward Voltage	VF	IF=20mA	-	U.S.L.*)×1.1
Reverse Current	IR	VR=5V	-	U.S.L.*)×2.0
Luminous Intensity	IV	IF=20mA	L.S.L**)×0.7	-

*) U.S.L.: Upper Standard Level

**) L.S.L: Lower Standard Level

2、Test Items And Results

Test Item	Reference Standard	Test Condition	Note	Number of Damaged
Resistance to Soldering Heat (Reflow Soldering)	JEITA ED-4701300 301	Tsld=260℃,10sec. (Pre treatment 30 ℃,70%,168hrs)	2times	0/50
Solder ability (Reflow Soldering)	JEITA ED-4701300 303	Tsld=215℃,3sec. (Lead Solder)	1time over 95%	0/50
Thermal Shock	JEITA ED-4701300 307	-40℃ ~ 100℃ 30min. 30min.	100cycles	0/50
Temperature Cycle	JEITA ED-4701100 105	-40℃ ~ 25℃~100℃~25℃ 30min. 5min. 30min. 5min	100cycles	0/50
High Temperature Storage	JEITA ED-4701200-201	Ta=100℃	1000hrs.	0/50
Temperature Humidity Storage	JEITA ED-4701100 103	Ta=60℃,RH=90%	1000hrs.	0/50
Low Temperature Storage	JEITA ED-4701200 202	Ta=-40℃	1000hrs.	0/50
Steady State Operating Life Condition		Ta=25℃,IF=20mA	1000hrs.	0/50
Steady State Operating Life of High Temperature		Ta=85℃,IF=5mA	500hrs.	0/50
Steady State Operating Life of High Humidity Heat		Ta=60℃,RH=90%,IF=15mA	500hrs.	0/50
Steady State Operating Life of Low Temperature		Ta=-30℃,IF=20mA	500hrs.	0/50

7.Others:

The appearance and specifications of the product may be modified for improvement without notice.

- PART NO. SYSTEM :

L – T 677 W D T Z – U1

- U1 : Special code for USA Sales customer
- Z: with Zener diode
- T : Taping for 7 inch reel
- Lens color
  D : Color Diffused
- Emitting color:
  W : InGaN + YAG White color
- Lead frame type:
  677:3528 PLCC4 series (SMD6723)
- T: PLCC Top View Type
- L:PARA LIGHT